

Ultralow Thermal Conductivity, Multiband Electronic Structure and High Thermoelectric Figure of Merit in TlCuSe

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Abstract

The entanglement of lattice thermal conductivity, electrical conductivity, and Seebeck coefficient complicates the process of optimizing thermoelectric performance in most thermoelectric materials. Semiconductors with ultralow lattice thermal conductivities and high power factors at the same time are scarce but fundamentally interesting and practically important for energy conversion. Herein, we describe an intrinsic *p*-type semiconductor TlCuSe that has an intrinsically ultralow thermal conductivity ($0.25 \text{ W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$), a high power factor ($11.6 \mu\text{W}\cdot\text{cm}^{-1} \text{ K}^{-2}$), and a high figure of merit ZT (1.9) at 643 K. The weak chemical bonds, originating from the filled antibonding orbitals *p-d** within the edge-sharing CuSe₄ tetrahedra and long Tl-Se bonds in the PbClF-type structure, in conjunction with the large atomic mass of Tl lead to an ultralow sound

velocity. Strong anharmonicity, coming from TI^+ lone-pair electrons, boosts phonon-phonon scattering rates and further suppresses lattice thermal conductivity. The multiband character of the valence band structure contributing to power factor enhancement benefits from the lone-pair electrons of TI^+ as well which modify the orbital character of the valence bands and pushes the valence band maximum off the Γ -point, increasing the band degeneracy. The results provide new insight on the rational design of thermoelectric materials.

Introduction

Thermoelectric (TE) materials, which can directly convert waste heat into electricity without emissions or moving parts, provide a convenient route of improving energy conversion efficiencies.^[1] One main challenge in TE technology is the low conversion efficiency of TE materials. The efficiency is defined by the figure of merit $ZT = S^2\sigma T/\kappa$, where T is the operating temperature, S is the Seebeck coefficient or thermopower, σ is the electrical conductivity, and κ is the thermal conductivity. Therefore, high ZT is desired for a TE material used in practical applications. However, it is not trivial to increase the ZT of a material because these TE properties are strongly intertwined. In the past decades, many efforts have been devoted to boosting ZT and significant improvements have been achieved by optimizing known TE materials and discovering new TE materials.^[2] The widely used strategies of enhancing power factor ($\text{PF}=S^2\sigma$) include band convergence,^[3] resonant levels,^[4] and quantum confinement effects^[5]. On the other hand, defects,^[6] solid solutions,^[7] nanostructures,^[6, 8] and hierarchical architectures^[9] are commonly utilized to suppress heat transfer through crystal lattices (κ_L). With these strategies, high TE performance has been achieved in many known TE materials such as $\text{AgPb}_m\text{SbTe}_{2+m}$ ($ZT=2.2$ at 800 K),^[10] PbTe-4\%SrTe ($ZT=2.2$ at 915 K),^[9] SnSe ($ZT=2.6$ at 923 K),^[11] FeNbSb ($ZT=1.5$ at 1200 K),^[12] Cu_2Se ($ZT=2.6$ at 850 K),^[13] and triple-filled skutterudite ($ZT=1.7$ at 850 K).^[14] Discovering new TE materials has been largely focused on finding semiconductors with intrinsically low κ_L .^[15] In kinetic theory,^[16] the κ_L is given by $\kappa_L = \frac{1}{3}C_v v_g^2 \tau$, where C_v , v_g , and τ are the specific heat, phonon group velocity, phonon relaxation time. The commonly used strategies of minimizing κ_L are to reduce τ through strong anharmonicity,^[17] rattling modes,^[18] liquid-like ions,^[19] et. al. and to lower v_g by lattice softening and structural complexity.^[20] With these strategies, many semiconductors with ultralow κ_L have been discovered, such as TlInSe_2 (0.5

W/m/K at 300 K),^[21] InTe (0.4 W/m/K),^[22] SnSe^[11], CsSnBr₃ (0.64 W/m/K at 300K),^[23] and Ag₈SnSe₆ (0.2 W/m/K at 300 K)^[20b].

There are fewer approaches to improve PF because S and σ have nearly opposite requirements on the electronic band structure. High density of states (DOS), which commonly exists in the less dispersive (flat) bands is important to enlarge the Seebeck coefficient, but leads to low electron mobility and σ . An effective route of solving this contradiction is to increase the band degeneracy (N_v). In a single parabolic band, the density of states effective mass (m^*_d) is related to the band effective mass (m^*_b) through N_v , namely $m^*_d = N_v^{2/3} m^*_b$. A large m^*_d can be achieved in a band with large N_v and small m^*_b . In ionic compounds, the conduction bands and valence bands typically consist of cation- s orbitals and anion- p orbitals respectively, resulting in direct gap semiconductors at the Γ -point, which has the lowest valley degeneracy and low N_v .^[20c, 24] However, the presence of the lone-pair electrons s^2 of cations can push the valence band maximum and the conduction band minimum away from the Γ -point and significantly increases N_v ,^[20c, 24] as observed in PbTe,^[25] BiCuSeO,^[26] and Li₂TlBi.^[27]

In this work, we describe an intrinsic p -type TE semiconductor TlCuSe with ultralow thermal conductivity ($0.25 \text{ W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$), a high power-factor ($11.6 \mu\text{W}\cdot\text{cm}^{-1}$), and high ZT (1.9) at 643 K. These favorable properties are a result of the ultralow sound velocity caused by the weak chemical bonds and high band degeneracy originating from the lone-pair electrons of Tl⁺. This new TE material presents a unique combination of the ultralow lattice thermal conductivity and high power-factor in a compound with a rather small unit cell. We determine the microscopic mechanisms behind these excellent TE properties, and this understanding can be used to discover and design new TE materials.

Crystal Structure and Phase Analysis. TlCuSe crystallizes in the PbClF-type structure (space group $P4/nmm$) with cell parameters of $a = 4.0870 \text{ \AA}$, $c = 8.1950 \text{ \AA}$, (Figure 1a).^[28] The structure shares the same layers of $[\text{CuSe}]^{1-}$ as the BiOCuSe compound with the difference being the $[\text{BiO}]^{1+}$ sub-layer is replaced by a bilayer of Tl⁺ atoms. The Cu atoms are coordinated with four Se atoms forming nearly regular CuSe₄ tetrahedra ($\text{Se-Cu-Se}' = 110.45^\circ$), which are connected with each other by sharing edges, forming antiferrotype $[\text{CuSe}]^{1-}$ layers (Figure 1b). Each Tl atom is located close to the $[\text{CuSe}]^{1-}$ layer, surrounded by four Se atoms on its residing layer (Tl-Se = 3.18 \AA), adopting a PbO-like connectivity (Figure 1c). The Tl atoms are further weakly bonded to a

fifth Se atom in the adjacent layer ($\text{Tl}\cdots\text{Se}' = 3.87 \text{ \AA}$) to form a square pyramid elongated towards its apex. Because of this interaction, the Se atoms themselves adopt an unusual 9-coordinate environment with four Cu atoms and four Tl atoms forming a square antiprism, capped in one of its square faces by a fifth Tl atom from the adjacent layer (Figure 1d). The interlayer interaction is mediated by the stereochemical expression of the $6s^2$ lone pair of Tl^+ , which is localized above the empty convex surface defined by the basal Se atoms surrounding Tl, pointing towards the adjacent layer along the crystallographic c -axis (Figure 1e). This situation creates a bilayer of $6s^2$ lone pairs of Tl^+ atoms in the middle of the space between the $[\text{CuSe}]^-$ slabs.

Figure 1f presents the powder X-ray diffraction (XRD) pattern of a TlCuSe sample after SPS sintering along with its simulated pattern, indicating that the synthesis product is a pure phase. According to DTA analysis, the compound melts at around 710 K (Figure 1g) without undergoing any solid-state phase transformation. The close temperature spacing between the melting and crystallization peaks attests to the high quality of the sample.

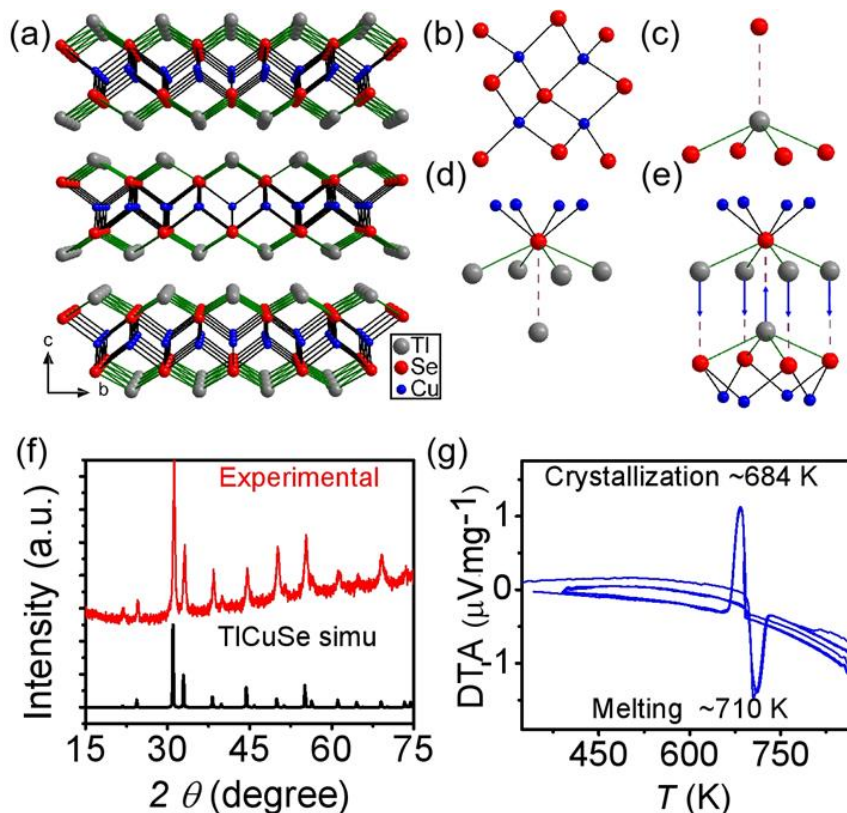


Figure 1. (a) Crystal structure of TlCuSe viewed along the a axis, (b) Antifluorite-type $[\text{CuSe}]^-$ layers, (c) Coordination environment of the Tl atom, (d) Coordination environment of the Se atom, (e) Interlayer

interaction between planes of Tl atoms and Se atoms, (f) powder XRD pattern of the TiCuSe sample after the SPS sintering, compared with the simulated XRD pattern of TiCuSe as a black line at the bottom and (g) Two cycles of DTA thermogram of the TiCuSe sample after the SPS process.

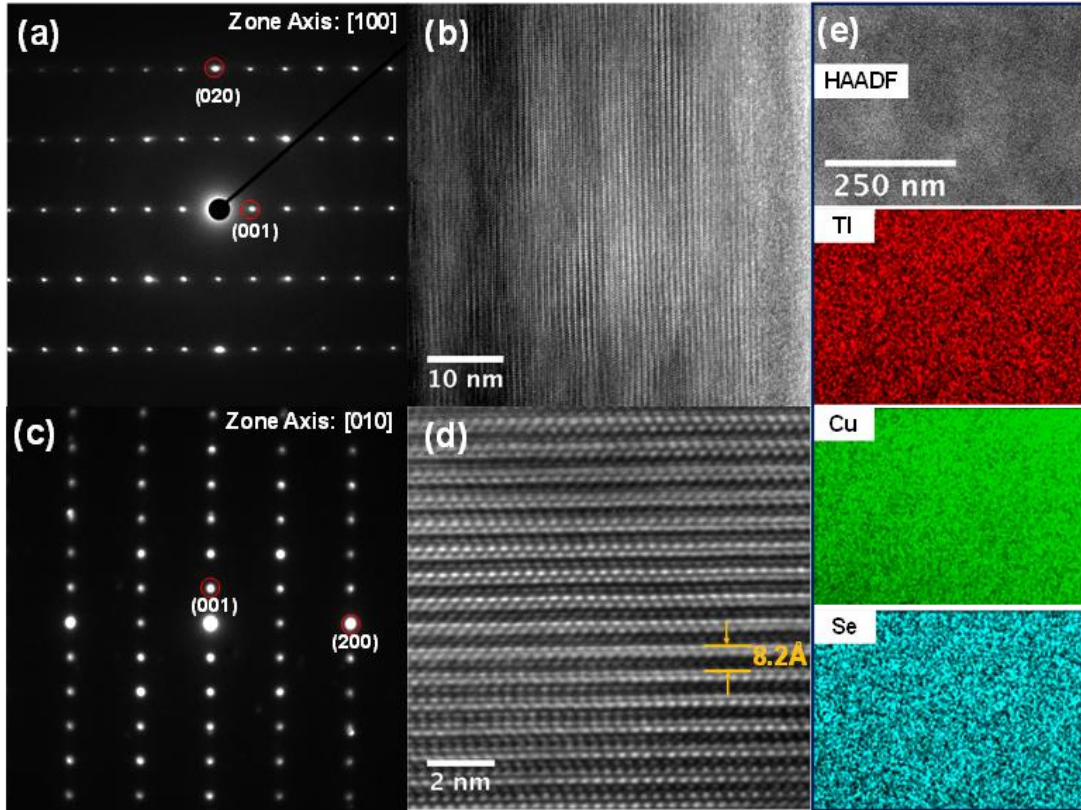


Figure 2. (a) Selected area electron diffraction (SAED) pattern and (b) high resolution TEM image (with a Wiener filter applied) of TiCuSe along the [100] zone axis. (c) SAED pattern and (d) high resolution TEM image of TiCuSe along the [010] axis. The highlighted spacing is $d_{001}=8.2 \text{ \AA}$. (e) HAADF STEM image and corresponding elemental EDS maps of TiCuSe. Ti, Cu and Se distribute uniformly throughout the region of interest. The contrast is due to thickness variation.

The quality and microstructure of the crystalline sample was further examined by TEM. Two FIB-lift-out TEM specimens were prepared for microstructure characterization along different zone axes. Figure 2a and 2b are a Selective Area Electron Diffraction (SAED) pattern and a High Resolution TEM (HRTEM) image of TiCuSe along the [100] direction, respectively. A Wiener filter was applied on Figure 2b to enhance the contrast and remove the contribution of amorphous phases introduced during specimen preparation. Figure 2c and 2d are the SAED pattern and

HRTEM image of TlCuSe along the [010] direction, respectively. The SAED patterns (Figure 4a and 4c) match with the simulated diffraction patterns for the $P4/nmm$ space group with no appearance of additional spots, confirming the high crystallinity of the specimens. In Figure 2d, the d -spacing of the (001) plane was measured to be approximately 8.2 Å, which is within reasonable agreement with $d_{001} = 8.195(1)$ Å from the XRD data. Figure 2e shows a representative High Angle Annular Dark Field (HAADF) STEM image with corresponding Energy Dispersive X-ray Spectroscopy (EDS) elemental maps of Tl, Cu and Se. All three elements distribute uniformly throughout the probed region; and the uneven contrast in both the HAADF image and elemental maps is mainly due to thickness variation within the characterized area.

Thermal Transport. Given the quasi 2-D nature of the crystal structure of TlCuSe can develop a preferential grain orientation during the pressing process, we examined the thermal and charge transport properties both parallel and perpendicular to the SPS pressing direction. As shown in Figure 3a, the room temperature total thermal conductivities perpendicular and parallel to the pressing direction are 0.70 and 0.44 $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$, respectively. Both values monotonically decrease with rising temperature and reach 0.40 and 0.25 $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$, respectively, at 643 K. Figure 3b displays the κ_L derived from the transport data (see Experimental Section in supporting information), indicating that the primary contribution to the total thermal conductivity of TlCuSe is from its lattice. The lattice contribution, κ_L , of TlCuSe are extremely low, 0.20 and 0.28 $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$ for the directions parallel and perpendicular to the pressing direction, respectively, at 643 K. These lattice thermal conductivities are even lower than those of SnSe as well as the Cu-based superionic TE material Cu_2Se .^[11, 19] For instance, the thermal conductivity of Cu_2Se is 1.0 $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$ at room temperature and drops to 0.7 $\text{W}\cdot\text{m}^{-1}\cdot\text{K}^{-1}$ at 1000 K.^[19] This low κ_L in a compound with a small unit cell is very unusual and we will analyzed this behavior next.

To understand the physical origin of the low κ_L , we begin with an analysis of the measured heat capacity data C_p by employing two different models: the Debye model that solely considers the contribution of acoustic phonons and a hybrid one that combines the Debye and the Einstein models including two localized vibrational modes (or Einstein oscillators) in addition to the Debye host. In the hybrid model, the relation between C_p/T and T^2 is expressed as:

$$\frac{C_p}{T} = \gamma + \beta T^2 + \sum_n \left(A_n (\Theta_{E_n})^2 (T^2)^{-3/2} \frac{e^{\Theta_{E_n}/T}}{(e^{\Theta_{E_n}/T} - 1)^2} \right) \quad (1)$$

In the above equation, the first term corresponds to the electronic contribution, the second term is from the Debye lattice contribution with $\beta = C \cdot (12\pi^4 N_A k_B / 5) \cdot (\theta_D)^{-3}$, where N_A , k_B , θ_D are Avogadro's number, the Boltzmann constant and the characteristic Debye temperature, respectively. The parameter C is given as $C = 1 - \sum_n A_n / 3NR$, where N is the number of atoms per formula unit and R is the gas constant. The third term represents the contribution from the Einstein oscillator modes, where n is the number of Einstein modes, while A_i and θ_{E_n} are the amplitude and the Einstein temperature of the i^{th} Einstein oscillator mode, respectively.

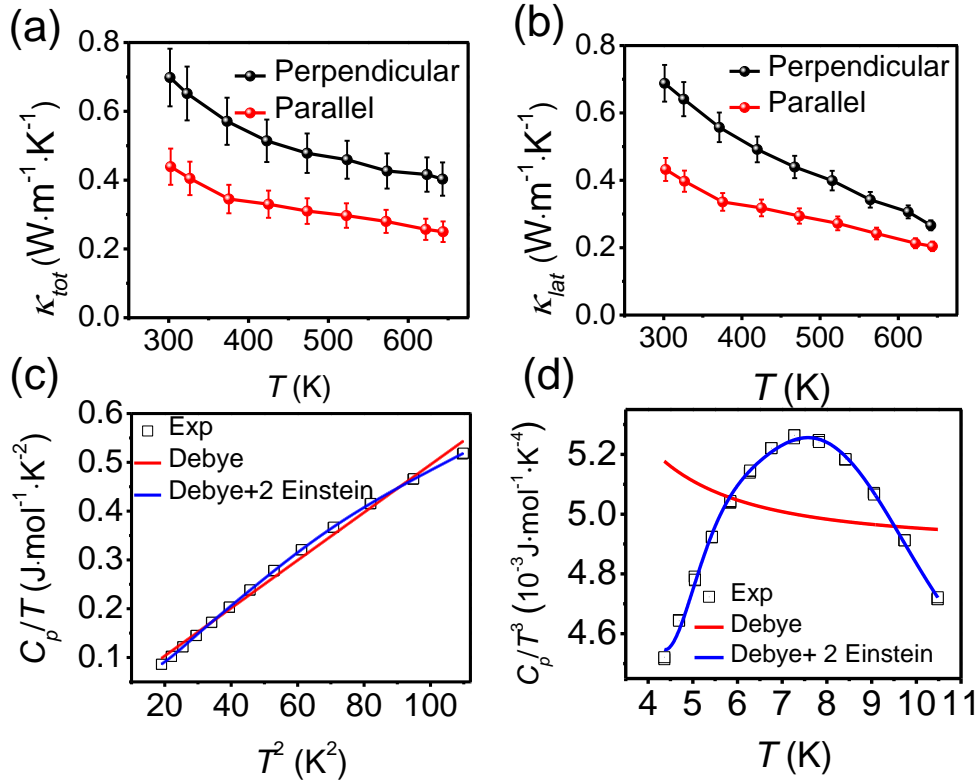


Figure 3. (a) Temperature dependence of total thermal conductivity for TiCuSe along two different directions (parallel and perpendicular to the pressing direction) and (b) temperature dependence of the lattice thermal conductivity in the two directions for TiCuSe. (c) C_p/T versus T^2 with fits shown using just the Debye model and a hybrid model combining both Debye and two Einstein vibrational modes. (d) C_p/T^3 versus T with fits shown using just the Debye model and a model incorporating both Debye and two Einstein vibrational modes.

Figure 3c shows the relation between C_p/T and T^2 measured between 20 K and 110 K. We see that the hybrid Debye + 2 Einstein model fits the experimental data very well (the fitting parameters are given in Table S1), whereas the Debye model with the conventional T^2 dependence clearly deviates from the data. This observation suggests the possible presence of other excitations, namely low frequency optical phonons, in addition to the acoustic phonon modes. Moreover, as shown in Figure 3d, a broad peak appears in the experimentally measured C_p/T^3 vs. T relation, which deviates considerably from the Debye model, but can be very well recovered using a hybrid Debye + 2 Einstein model. This type of peak is often found in low temperature heat capacity data of disordered glasses, as well as in clathrates and skutterudites, and has been attributed to the excess phonon density of states (DOS) resulting from guest-induced low-lying optical modes^[29].

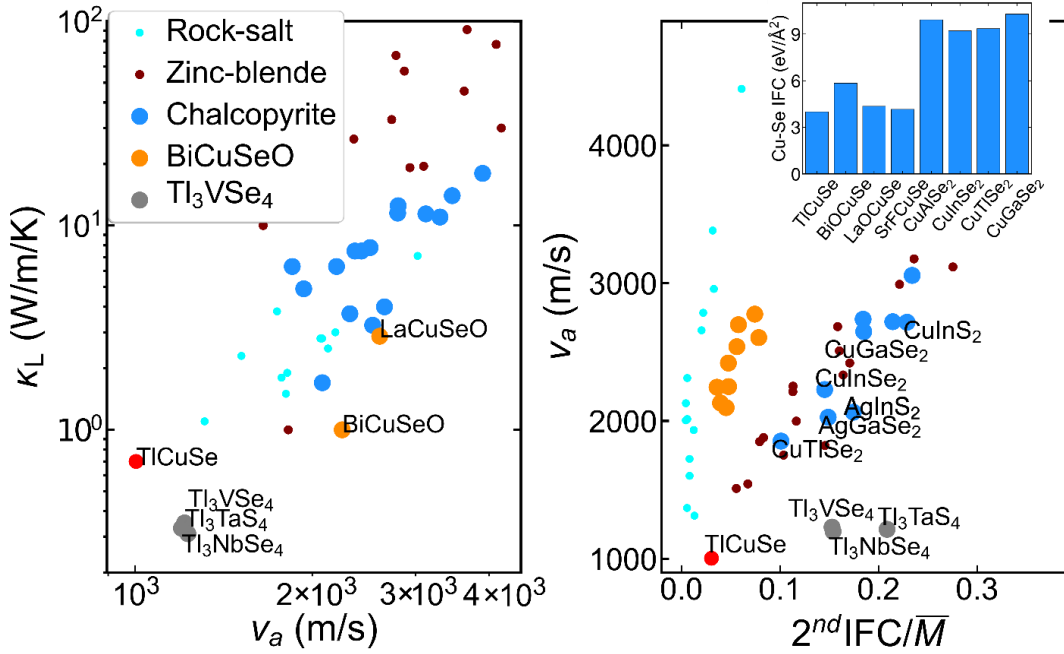


Figure 4. (a) Experimentally measured lattice thermal conductivity (κ_L at 300 K) versus computed average sound velocity (v_a) and (b) v_a versus the average mass (\bar{M}) normalized second-order interatomic force constants ($2^{nd} IFC$) for compounds with different crystal structures. The size of the dot corresponds to the number of atoms per primitive unit cell. Inset is the force constant between Cu and Se for compounds containing CuSe₄ tetrahedra.

In $TlCuSe$, the excess contribution to C_p at low temperatures may be associated with the low-energy optical modes from the weakly bound Cu^+ and rattling-like Tl^+ ions, which will be discussed in detail in the subsequent section. It has been pointed out in recent studies that these

low-lying optical modes coupled with heat-carrying acoustic modes not only reduce the v_g but also enhance phonon scattering (τ^{-1}), thus leading to the observed ultralow κ_L .^[30] Similar phenomenon has been observed in several other materials such as $(\text{Bi,Sb})_2\text{Te}_3$, MgAgSb , Cu_3SbSe_3 and TlInTe_2 ^[21, 31], all of which exhibit intrinsically very low thermal conductivity.

A key factor that we find contributes to the very low thermal conductivity in TlCuSe is its very low average sound velocity (v_a) of about 886 m/s, which is the long wavelength limit of v_g and can be calculated from the fitted Debye temperature ($\Theta_D = 94.4$ K, see Table S1). To the best of our knowledge, this is the lowest v_a among the known TE materials (the previous one with the lowest v_a is Ag_8GeTe_6 is 1009 m/s).^[20b, 32] To further illustrate this, we show in Figure 4a the experimentally measured κ_L and our DFT calculated v_a for the semiconductors with several common crystal structures. Note that these DFT calculated v_a might be slightly larger than the measured values due to the presence of thermal expansion and defects in the synthesized samples and the approximations due to the exchange-correlation functional (PBEsol) in the DFT calculations. As expected, we see a strong correlation between v_a and κ_L . In particular, small v_a is usually associated with small κ_L and vice versa, especially within the same category of crystal structure. On the other hand, crystal structure also plays an important role in determining κ_L , e.g. rock-salt compounds tend to have smaller κ_L than those of the zinc-blende compounds exhibiting similar values of v_a , due to different phonon-phonon scattering rates in these two structures^[33]. We see that among these compounds, TlCuSe has the lowest v_a and a very low κ_L , whose values are close to those of Tl_3MX_4 ($M=\text{V, Nb, and Ta}$; $X=\text{S and Se}$).^[34] These Tl-based chalcogenides are known to have the lowest κ_L among compounds with relatively simple structures and a small number of atoms in the unit cell. This indicates that the mechanism behind the low v_a reported here is sharply different from that of crystal structures with large/complex unit cells.^[35] It is even more intriguing to notice that although many other Cu-Se compounds also have low κ_L , as shown in Figure S1, TlCuSe has a much simpler crystal structure and smaller unit cell.

To explore the origin of the low v_a in TlCuSe , we plot v_a versus the second-order interatomic force constant normalized by the average mass ($2^{\text{nd}}\text{IFC}/\bar{M}$) of the compounds with common crystal structures in Figure 4b. TlCuSe has a smaller $2^{\text{nd}}\text{IFC}/\bar{M}$ than all the other compounds except a few with the rock-salt structure, which generally has a small IFC (weak bonding interaction) due to its

high coordination number.^[20c] The large value of \bar{M} , due to Tl, and the small 2ndIFC indicates weak bonding between the constituent atoms in TlCuSe. The weak Tl-Se bond can be seen from its long bond length (3.18 Å), which is commonly observed in Tl⁺ compounds such as Tl₃MSe₄ ($M=V, Nb,$ and Ta). Interestingly, we find that the Cu-Se bond in TlCuSe is also very weak. As we can see from the inset of Figure 4b, the 2ndIFC between Cu and Se in TlCuSe is nearly three times smaller than that in chalcopyrite (with corner-sharing CuSe₄ tetrahedra), but is comparable with that in the BiCuSeO-type structure, (with edge-sharing CuSe₄ tetrahedra in the layer direction), the same as TlCuSe. This observation is consistent with Pauling's third rule that the sharing of edges and faces by two polyhedra substantially decreases the stability (elongates cation-anion bond length) of an ionic structure, due to the Coulomb repulsion between cations in two adjacent polyhedra.^[36] Indeed, the Cu-Se bond length in TlCuSe and BiCuSeO (~2.5 Å) is longer than that in chalcopyrite (~2.4 Å). We can also understand the weak Cu-Se bond in terms of the electronic structure. Cu-Se bonds in all these compounds have anti-bonding orbitals below the Fermi level due to the unusual $d-p$ coupling between Cu-3d and Se-4p orbitals,^[37] see crystal orbital Hamilton population (COHP) analysis for these compounds in Figure S2. The filling of the anti-bonding states decreases the bond order and destabilizes the Cu-Se bond, thus leading to weak interatomic interactions, which may partially explain why Cu⁺-based semiconductors have low κ_L in general.^[38] Our analysis reveals that weak Cu-Se and Tl-Se bonds and heavy atomic mass can be viewed as the major origin of the low ν_a in TlCuSe.

Phonon Dispersion: To gain more insight into the lattice dynamics in TlCuSe, we performed phonon calculations based on DFT force constants. The phonon dispersion curves in the first Brillouin zone and the corresponding projected density of states (PDOS) at 0 K are shown in Figure 4a. The phonon dispersion shows that there are small imaginary frequencies at M (M_1 , ~ 13i cm⁻¹) and along the line between Γ and X (Δ_1 , ~ 10i cm⁻¹). We have confirmed that these imaginary frequencies are independent on the choice of exchange-correlation function and displacement amplitude of phonon calculations (see Figure S3). The atom displacement of the M_1 mode, reveals that the Cu⁺ cation exhibits much larger amplitudes than all other atoms, see Figure S4. Moreover, we find that displacing the atoms along the eigenvectors of the unstable M_1 mode leads to a subgroup structure $Pbcm$ only 2 meV/atom lower than the observed $P4/nmm$ phase. The small imaginary frequency and energy difference indicate that any phase transition from $Pbcm$ to $P4/nmm$ is likely at very low temperature and only the $P4/nmm$ structure can be observed at room

temperature, which is consistent with the experimental observation. We note that investigating the behavior of these imaginary phonon modes at finite temperatures is certainly of great interest, but beyond the scope of current study, which will be left for a future study. The PDOS shows that the low-frequency phonon branches ($\sim 18 \text{ cm}^{-1}$) are mainly from the Tl, due to its heavy mass and weak Tl-Se bond. Although Cu has the smallest atomic mass in TlCuSe, Cu does have a remarkable contribution to the low-frequency modes as well, which can be clearly viewed from the large atom displacements in real space, see Figure S4. This is consistent with the weak Cu-Se bond in the edge-sharing CuSe_4 tetrahedra as discussed before. Finally, the low frequencies of acoustic phonons along Γ -Z direction originate from the weak interlayer bonding interactions.

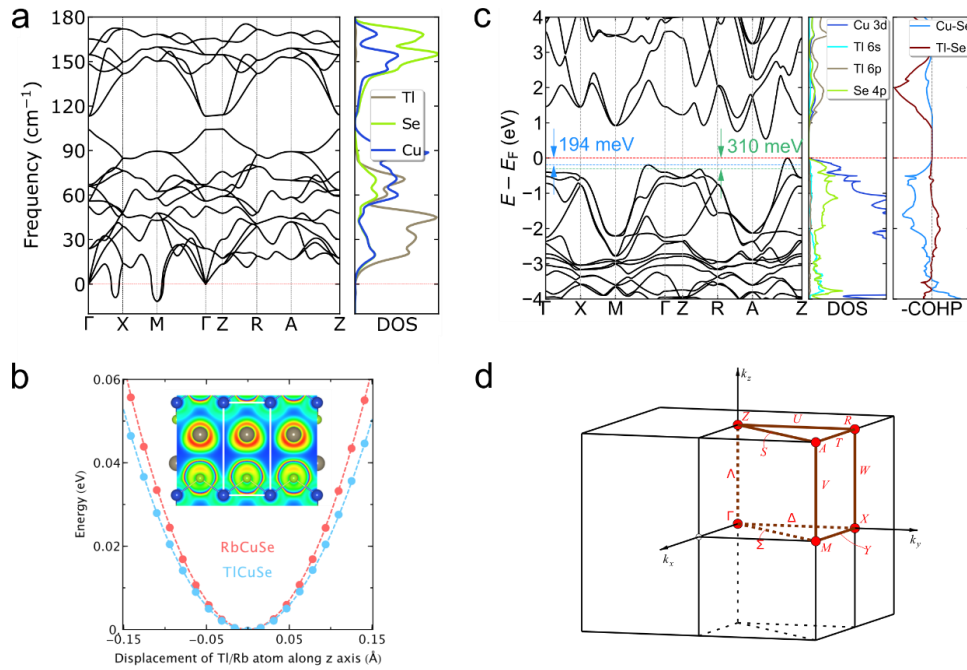


Figure 5. TlCuSe: **(a)** phonon band structures along with phonon density of states at 0 K. **(b)** energy change (ΔE) of displacing Tl and Rb along c axis with respect to the equilibrium position of TlCuSe and RbCuSe. The inset shows the electron localization function of TlCuSe. **(c)** Electronic band structure, projected density of states, and the atom projected crystal orbital Hamiltonian population (COHP) of TlCuSe calculated with HSE06. Spin-orbit coupling is included in the band structure and DOS calculations but not in COHP. **(d)** The first Brillouin zone of the $P4/nmm$ space group.

Since Tl^+ has lone-pair electrons ($6s^2$), we study the impact of lone-pair electrons on the potential energy surface (PES) by displacing Tl along the c axis (the direction that the lone-pair electrons pointing towards), comparing with Rb^+ in the same structure, which has similar ionic radius but no lone-pair electrons. The PES of Tl atom has lower energy and stronger anharmonicity (the 3rd-order onsite force constant is $0.51 \text{ eV}/\text{\AA}^3$) than those of Rb (the 3rd-order onsite force constant is $0.18 \text{ eV}/\text{\AA}^3$), which is evidence of the effects from the lone-pair electrons. The electron localization function in Figure 5b clearly indicates the lone-pair electrons of Tl^+ pointing along the c axis. Strong anharmonicity significantly increases the phonon-phonon scattering rate and reduces phonon relaxation time (τ). Therefore, we find that the ultralow κ_L of TlCuSe originates from the low phonon velocity (v_a) and short phonon lifetime (τ).

Electronic Band Structures. The calculated electronic band structure and projected density of states (PDOS) of TlCuSe are shown in Figure 5c, along with the first Brillouin zone of the $P4/nmm$ space group in Figure 5d. It is clear that TlCuSe has a multiband character which is highly beneficial to its PF. The HSE06 calculated band gap, including spin-orbit coupling (SOC), is 0.59 eV, in good agreement with the activation energy derived from the temperature-dependent carrier concentration (Figure 6f). The valence band maximum (VBM) is located in the middle of the S line (along A-Z) in the first Brillouin zone and has a band degeneracy (valley degeneracy \times energy degeneracy) of $N_v = 4$. The second and third maxima are along the Σ ($N_v = 4$) and U ($N_v = 4$) lines, sitting 194 meV and 310 meV lower than the VBM, respectively. Thus, hole doping and temperature broadening of the Fermi level can generate carriers from multiple regions of reciprocal space. The calculated band effective mass (m_d^*) of the hole (electron) along A-Z direction is 0.3 (0.2) m_0 , indicating a high carrier mobility. The DOS effective mass (m_b^*) of holes and electrons are enlarged by the high band degeneracy as $m_d^* = N_v^{2/3} m_b^*$, which can enhance the Seebeck coefficient without impairing the electrical conductivity.^[39] The multiband character of TlCuSe derives from the hybridization between the filled $6s$ lone-pair-electrons, empty $6p$ orbitals in Tl^+ and filled $4p$ orbitals of Se. This hybridization can be better illustrated by comparing and contrasting with the band structure of NaCuSe which has the same structure and CuSe layer but the Na^+ has no lone-pair-electrons. In NaCuSe both VBM and CBM occur at the Γ point. As shown in Figure S5, the hybridization between the $6s$ -orbitals of Tl^+ and the $4p$ -orbitals of Se shifts the VBM from Γ to the middle of the S line since the s -like band always increases from the Γ point (σ bonding between s -orbitals) to the Brillouin zone boundary (σ anti-bonding between s -orbitals).^[24]

Similarly, the hybridization between the $6p$ -orbitals of Tl^+ and the $4p$ -orbitals of Se shifts the CBM from the Γ to the S line. The strong p - d coupling between Cu $3d$ and Se $4p$ states can be clearly seen in the DOS and COHP of Figure 5c, which leads to filled anti-bonding levels below the Fermi level and weakened Cu-Se bonding, as noted above.^[37a]

Thermoelectric Performance: Figure 6a shows the temperature dependent charge transport properties of TlCuSe measured along two different pressing directions. The electrical conductivity increases with rising temperature while the Seebeck coefficient decreases, which is typical for semiconductors. Since there is a preferential orientation of the layers perpendicular to the SPS pressing direction measurements were made both parallel and perpendicular to the pressing directions. For example, at 643 K, the electrical conductivity of the sample measured perpendicular ($139 \text{ S}\cdot\text{cm}^{-1}$) to the pressing direction is more than twice higher than that measured parallel ($47 \text{ S}\cdot\text{cm}^{-1}$) to it, consistent with the TlCuSe layers providing the primary carrier transport path.

The Seebeck coefficients are positive in the whole measured temperature range, indicating holes are the dominant charge carriers (Figure 6b). The Seebeck coefficient has a relatively large difference in the parallel and perpendicular directions, especially at high temperature. Such large Seebeck anisotropy is rare, so theoretical calculations were carried out to offer an insight into the origin of this anisotropy. The calculated Seebeck (S) coefficient as a function of the hole concentration is shown in Figure S6. The calculated S at 300 K agrees with the experiment very well but is underestimated at the higher temperature, probably due to the uncertainty of the band gap and hole concentration at high temperature.

The Hall coefficient decreases rapidly as the carrier concentration N is thermally activated with increasing temperature, Figure 6c. The TlCuSe sample exhibits a self-doped p -type carrier concentration of $N = 5.9 \times 10^{18} \text{ cm}^{-3}$ at room temperature, probably originating from Cu vacancies, and the carrier concentration sharply increases by two orders of magnitude with rising temperature ($2.2 \times 10^{20} \text{ cm}^{-3}$ at 623 K) attributed to the onset of intrinsic carrier excitations. This is consistent with the positive Seebeck coefficient whose magnitude decreases with rising temperature. According to the Arrhenius-type equation, $N \propto e^{-E_g/2k_B T}$, in the intrinsic regime, we can extract a band gap energy E_g for TlCuSe of around $0.56 \pm 0.03 \text{ eV}$ (the inset in Figure 6d). The charge carrier mobility displayed in Figure 6f demonstrates that the scattering exponent ν in the mobility power law, $\mu \propto T^\nu$, begins around $-3/2$ near room temperature then drops ($\nu \leq -5/2$) at higher

temperatures. Charge carrier scattering by acoustic phonons is therefore the dominant mechanism, with increased charge carrier effective mass playing a role at elevated temperatures.

Note that the measured hole concentration is based on the assumption of a single parabolic band, which is not the case in this compound. From our calculations, the observed anisotropy of S at high temperature is consistent with the experiment. At low temperature (300 K) and for low carrier concentrations ($\sim 10^{19} \text{ cm}^{-3}$), the out-of-plane Seebeck coefficient (S_{\parallel}) is nearly the same as the in-plane one (S_{\perp}), and the system shows an isotropic S . At higher temperature, e.g., 600 K, and high hole concentration (due to thermal excitation), S_{\perp} is obviously larger than S_{\parallel} by the contribution from the top of the valence band (the peak along A-Z direction), see the inset of Figure S6(b). Within the rigid band approximation, Seebeck coefficient and electrical conductivity are given in Mott formula^[40]

$$S = \frac{\pi^2 K_B^2}{3 e} T \left[\frac{d \ln \sigma(E)}{dE} \right]_{E=E_F} \approx \frac{\pi^2 K_B^2}{3 e} T \left[\frac{d \ln N}{dE} \right]_{E=E_F} \quad (2)$$

$$\sigma(E) = \frac{e^2}{3} \tau(E) v^2(E) N(E) \quad (3)$$

where K_B , $\tau(E)$, $v(E)$, $N(E)$ are the Boltzmann constant, energy-dependent relaxation time, carrier velocity, and density of states, respectively. Therefore, a large derivative of $N(E)$ with respect to E at the Fermi level leads to a large S . With the temperature and hole concentration increasing in TiCuSe, the Fermi level approaches the dispersive band along A-Z direction (see Figure S6) and the change of the $N(E)$ with respect to E within the plane perpendicular to the layer direction decreases. However, the flat band along Γ -Z direction keeps a relatively large $\frac{d \ln N}{dE}$ and therefore a large S along the layer direction.

Because of the higher electrical conductivity perpendicular to the pressing direction, the power factor in this direction is much larger than that along the pressing direction, as shown in Figure 6e. The highest power factor of $11.6 \text{ W} \cdot \text{cm}^{-1} \cdot \text{K}^{-2}$ was observed at 643 K which coupled with the ultralow thermal conductivity result in a very high ZT of 1.9 at 643 K (Figure 6f) perpendicular to the SPS pressing direction. It should be noted that the TiCuSe materials in this study are not heavily doped nor optimized for best performance, and therefore further modulation of TiCuSe is warranted to achieve even higher ZT . Comparing with the best Cu-based thermoelectric materials such as Cu_2Se , TiCuSe does not seem to have a Cu migration issue, similar to the layered BiCuSeO.

TiCuSe has a lower melting point than PbTe, which reaches the highest ZT at ~ 1000 K, however, it has a lower intrinsic κ_L than both PbTe and Cu₂Se and therefore could achieve much higher ZT if could be further doped.

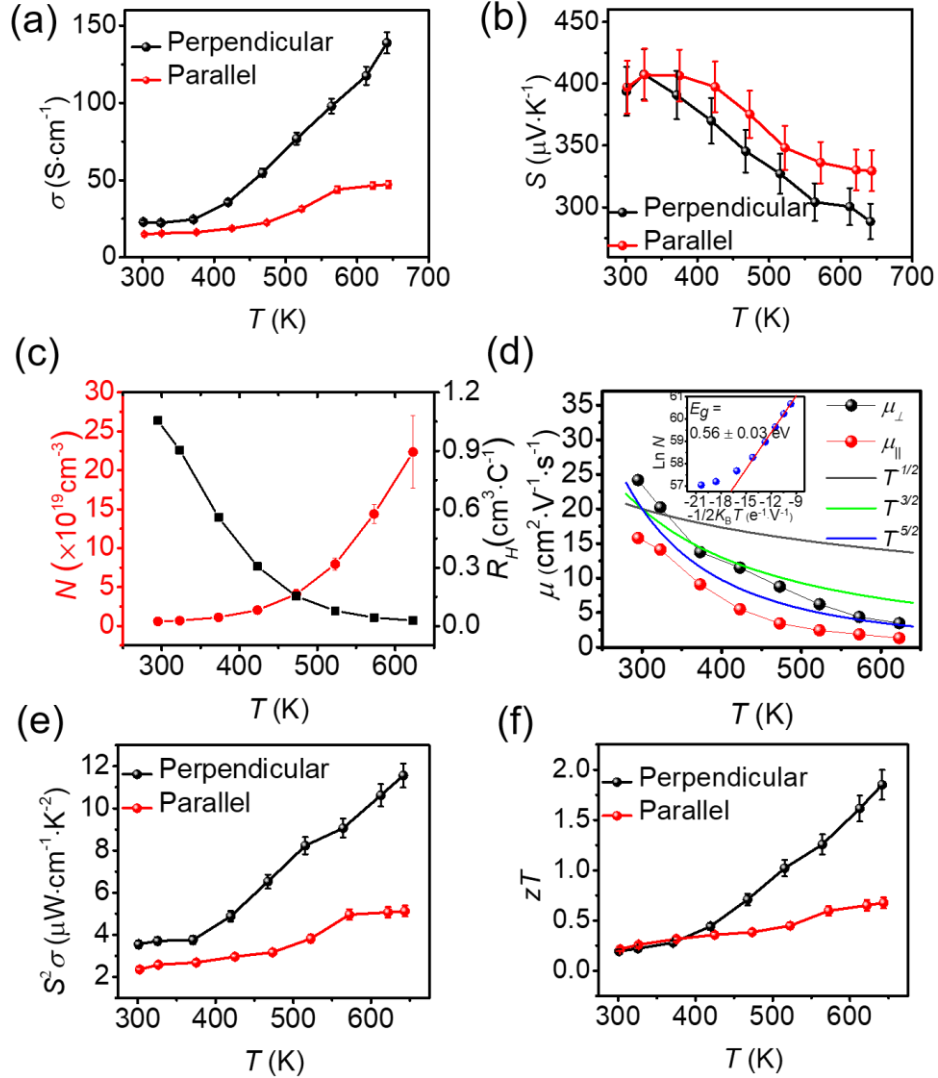


Figure 6. Temperature dependence of (a) electrical conductivity, (b) Seebeck coefficient, (c) power factor, and (d) the dimensionless ZT for TiCuSe measured parallel and perpendicular to the pressing directions. (e) Temperature dependence of the carrier concentration and the Hall coefficient for TiCuSe. (f) Temperature dependence of the charge carrier mobility. The inset is the fitting of activation energy based on the Arrhenius equation.

CONCLUSIONS

TlCuSe exhibits an ultralow lattice thermal conductivity ($0.25 \text{ Wm}^{-1}\text{K}^{-1}$) and a high power factor ($11.6 \mu\text{W}\cdot\text{cm}^{-1} \text{ K}^{-2}$) at 643 K in the intrinsic semiconducting samples, which result in a high figure of merit ZT (1.9). DFT calculations uncover the complex mechanism underlying the low thermal conductivity of this compound: The weak chemical bonds between the constituent atoms, high average atomic mass, and strong anharmonicity from the lone-pair electrons of Tl^+ give rise to ultralow sound velocity and short phonon relaxation times. The lone-pair electrons Tl-6s^2 also modify the orbital character of the valence bands and pushes the valence band maximum away from the Γ -point, increasing the band degeneracy and therefore the power factor. The unique microscopic mechanisms uncovered in this compound could also inspire thermoelectric materials studies in future.

Methods

Electron Microscopy: Scanning/Transmission Electron Microscopy (SEM/TEM) studies were carried out with a JEOL ARM300F GrandARM TEM operated at 300 kV and a JEOL 2100F TEM operated at 200 kV. TEM specimens were prepared using a Focused Ion Beam (FIB) lift-out technique with a FEI Helios Nanolab SEM/FIB. Prior to FIB ion milling, a layer of amorphous carbon was deposited on the region of interest to protect its surface integrity. Bulk FIB milling techniques with Ga ion beam at 30 kV were used to reduce the specimen thickness to about $1 \mu\text{m}$. The specimens were then transferred with an Omniprobe to a molybdenum Lift-Out TEM Grid and further thinned with low energy Ga ions to achieve electron transparency with minimal ion-induced damage. To minimize damages by electron beam and any heat generated, the specimen was characterized at a cryogenic temperature ($< 123 \text{ K}$) using a Gatan Cryo-Transfer Holder. The specimen preparation and handling were performed in an Ar-filled glove box. A Wiener filter was applied to one of the high resolution TEM images using a HRTEM Filter Digital Micrograph™ script (http://www.dmscripting.com/hrtem_filter.html).

Electrical Properties. The SPS-processed pellets (dimension: $3 \times 3 \times 10 \text{ mm}^3$) of TlCuSe were cut into bars both perpendicular and parallel to the sintering pressure directions for electrical property measurement. The samples were spray-coated with boron nitride film to minimize outgassing while heating, except places needed for electrical contact with the thermocouples, heater, and voltage probes. The Seebeck coefficients and electrical conductivities were measured

simultaneously with an Ulvac Riko ZEM-3 instrument under a low-pressure helium atmosphere and a temperature ranging from room temperature to 633 K. The uncertainty of the measured Seebeck coefficient and electrical conductivity is about 5%.^[41]

Thermal Conductivity. The thermal diffusivity coefficient (D) measurements were conducted with the samples with a dimension of $6.00 \times 6.00 \times 1.00 \text{ mm}^3$, as shown in Figure S7 in Supporting Information. The thermal diffusivities on samples cut both perpendicular and parallel to the sintering pressure directions were measured by using Netzsch LFA457 instrument. The samples were coated with graphite to for a uniform heat emissivity over the whole sample area. A Cowan model with pulse correction was used for the thermal diffusivity analysis. The total thermal conductivity was calculated by the equation $\kappa_{\text{tot}} = DC_p d$, where d is the density calculated by using the mass and the volume of the sample. The specific heat (C_p) was calculated by the Dulong-Petit law $C_p = 3R/\bar{M}$, where R is the gas constant $8.314 \text{ J}\cdot\text{mol}^{-1}\cdot\text{K}^{-1}$ and \bar{M} is the average molar mass of TiCuSe. The uncertainty of the thermal conductivity is estimated to be within 8% and the uncertainty in calculation of ZT is 15%.^[41] Thermal conductivity (κ_{tot}) is composed of two contributions, electrical thermal conductivity (κ_{ele}) and lattice thermal conductivity (κ_{lat}). The lattice thermal conductivity can be obtained by subtracting κ_{ele} from κ_{total} .

$$\kappa_{\text{lat}} = \kappa_{\text{tot}} - \kappa_{\text{ele}} = \kappa_{\text{tot}} - L\sigma T \quad (3)$$

Here, κ_{ele} is estimated by the Wiedemann–Franz relation: $\kappa_{\text{ele}} = L\sigma T$, where σ is the electrical conductivity and L is the Lorenz number. Assuming a single parabolic band model, the Lorenz number L is calculated as^[42]

$$L = \left(\frac{k_B}{e}\right)^2 \left[\frac{(r+7/2)F_{r+5/2}(\eta)}{(r+3/2)F_{r+1/2}(\eta)} - \left[\frac{(r+5/2)F_{r+3/2}(\eta)}{(r+3/2)F_{r+1/2}(\eta)} \right]^2 \right] \quad (4)$$

Here, the reduced Fermi energy η can be obtained from the Seebeck coefficient as

$$\alpha = \pm \frac{k_B}{e} \left[\frac{(r+5/2)F_{r+3/2}(\eta)}{(r+3/2)F_{r+1/2}(\eta)} - \eta \right] \quad (5)$$

$$F_n(\eta) = \int_0^\infty \frac{\chi^n}{1+e^{\chi-\eta}} d\chi \quad (6)$$

where k_B is the Boltzmann constant, e is the electron charge, α is the Seebeck coefficient, and r is the scattering factor; here, $r = -1/2$ for charge carrier scattering by acoustic phonons.

Hall measurements. The Hall coefficient measurement was performed by a homebuilt system using an AC 4-probe method with excitation magnetic fields of +0.5 and -0.5 T. The system used an air-bore, helium-cooled superconducting magnet to generate the field within a high temperature oven that surrounds the Ar gas-filled sample probe. The carrier density was calculated from the Hall coefficient assuming a single carrier, i.e. $n = 1/R_H$, where R_H is the Hall coefficient. The estimated error of the measurement is around 3% at the 10^{19} cm^{-3} level of carrier density but becomes larger at the 10^{20} cm^{-3} level based on the standard deviation of several data points at a single temperature. The charge carrier mobility was calculated as $\mu = \sigma R_H$.

Temperature-dependent heat capacity measurements. Heat capacity was measured using a Dynacool Physical Property Measurement System (PPMS, Quantum Design) between 1.8 and 300 K. Apiezon N grease was used to fix polycrystalline samples prepared by SPS to the sample stage.

Computational methods. All density functional theory (DFT) calculations are performed using the Vienna *Ab-initio* Simulation Package (VASP),^[43] with a plane wave basis set and projector-augmented wave (PAW) pseudo potentials.^{[44] [45]} The PBEsol functional is used for crystal structure relaxation and phonon related properties calculations,^[46] which yielded lattice constants of $a = b = 4.00 \text{ \AA}$ and $c = 8.21 \text{ \AA}$. The screened hybrid functional HSE06 is adopted for electronic structure calculations.^{[47] [48]} Spin-orbit coupling (SOC) is included. The second force constants are computed by using the Phonopy,^[49] with $4 \times 4 \times 2$ supercells (192 atoms). The phonon spectra at room-temperature is computed with the self-consistent phonon approximation (SCPH), which comprises the first-order correction from quartic anharmonicity.^[50] The three and fourth-order force constants are calculated by using the compressive sensing lattice dynamics (CSLD).^[51] The lattice thermal conductivity is calculated by solving the linearized Boltzmann transport equation using ShengBTE.^[52] The average speed of sound (v_a) is calculated from bulk (B) and shear (G) moduli as^[53]

$$v_a = \left[\frac{1}{3} \left(\frac{1}{v_L^3} + \frac{2}{v_T^3} \right) \right]^{-1/3} \quad (7)$$

$$v_T = \sqrt{\frac{G}{\rho}} \quad (8)$$

$$v_L = \sqrt{\frac{B + \frac{4}{3}G}{\rho}} \quad (9)$$

where v_L and v_T are longitudinal and transversal sound velocities, respectively. ρ is the mass density. B and G are calculated from elastic constants.

ACKNOWLEDGMENTS

This work was supported in part by a grant from the U.S. Department of Energy, Office of Science, and Office of Basic Energy Sciences under Award Number DE-SC0014520 (synthesis and characterization of thermoelectric materials). The authors acknowledge the computing resources provided by the National Energy Research Scientific Computing Center (NERSC), a U.S. Department of Energy Office of Science User Facility operated under Contract No. DE-AC02-05CH11231 (heat capacity measurements).

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